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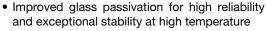
Vishay Semiconductors

Medium Power Phase Control Thyristors (Stud Version), 22 A



PRODUCT SUMMARY				
Package	TO-208AA (TO-48)			
Diode variation	Single SCR			
I _{T(AV)}	22 A			
V _{DRM} /V _{RRM}	100 V to 1200 V			
V _{TM}	1.70 V			
I _{GT}	60 mA			
T _J	-65 °C to 125 °C			

FEATURES





- High dl/dt and dV/dt capabilities
- Standard package
- · Low thermal resistance
- · Metric threads version available
- Types up to 1200 V V_{DRM}/V_{RRM}
- Designed and qualified for industrial and consumer level
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

- · Medium power switching
- Phase control applications
- Can be supplied to meet stringent military, aerospace and other high reliability requirements

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
1		22	А		
I _{T(AV)}	T _C	85	°C		
I _{T(RMS)}		35	А		
I _{TSM}	50 Hz	400	^		
	60 Hz	420	Α		
l ² t	50 Hz	793	A2-		
	60 Hz	724	A ² s		
V _{DRM} /V _{RRM}		100 to 1200	V		
tq	Typical	110	μs		
TJ		-65 to 125	°C		

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS							
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE ⁽¹⁾ V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE ⁽²⁾ V	I_{DRM}/I_{RRM} MAXIMUM AT $T_J = T_J$ MAXIMUM mA			
	10	100	150	20			
	20	200	300				
	40	400	500				
VS-22RIA	60	600	700	10			
	80	800	900	10			
	100	1000	1100				
	120	1200	1300				

Notes

- (1) Units may be broken over non-repetitively in the off-state direction without damage, if dl/dt does not exceed 20 A/µs
- (2) For voltage pulses with $t_p \le 5$ ms



PARAMETER	SYMBOL		TEST CONI	DITIONS	VALUES	UNITS
Maximum average on-state current					22	Α
at case temperature	I _{T(AV)}	180° sinuso	oidal conduction		85	°C
Maximum RMS on-state current	I _{T(RMS)}				35	Α
		t = 10 ms	No voltage		400	
Maximum peak, one-cycle		t = 8.3 ms	reapplied		420	A
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		335	1 ^
		t = 8.3 ms	reapplied	Sinusoidal half wave,	355	1
Maximum I ² t for fusing		t = 10 ms	No voltage initial T _J =T _J maximum reapplied	793		
	l ² t	t = 8.3 ms			724	A ² s
		t = 10 ms			560	
		t = 8.3 ms			515	
Maximum I ² √t for fusing	I ² √t	t = 0.1 to 10 ms, no voltage reapplied, $T_J = T_J$ maximum		7930	A²√s	
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), $T_J = T_J$ maximum		0.83	V	
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)})$	$f_{\rm J}$), $T_{\rm J} = T_{\rm J}$ maxim	um	0.95] v
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), $T_J = T_J$ maximum		14.9	0	
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		13.4	mΩ	
Maximum on-state voltage	V _{TM}	I _{pk} = 70 A, T _J = 25 °C		1.70	V	
Maximum holding current	I _H	T _ 05 °C	anada aunnis 6	V registive lead	130	- mA
Latching current	ΙL	T _J = 25 °C, anode supply 6 V, resistive load			200] IIIA

SWITCHING					
PARAMETER	METER SYMBOL TEST CONDITIONS		TEST CONDITIONS	VALUES	UNITS
	$V_{DRM} \le 600 \text{ V}$			200	
Maximum rate of rise	$V_{DRM} \le 800 \text{ V}$	dl/dt	$T_J = T_J$ maximum, $V_{DM} = Rated\ V_{DRM}$ Gate pulse = 20 V, 15 Ω , $t_p = 6\ \mu s$, $t_r = 0.1\ \mu s$ maximum $I_{TM} = (2\ x\ rated\ dl/dt)\ A$	180	A/μs
of turned-on current	$V_{DRM} \le 1000 \text{ V}$			160	
	$V_{DRM} \le 1600 \text{ V}$			150	
Typical turn-on time		t _{gt}	T _J = 25 °C, at rated V _{DRM} /V _{RRM} , T _J = 125 °C	0.9	
Typical reverse recovery time		t _{rr}	$T_J = T_J$ maximum, $I_{TM} = I_{T(AV)}$, $t_p > 200 \ \mu s$, $dI/dt = -10 \ A/\mu s$	4	μs
Typical turn-off time		t _q	$T_J=T_J$ maximum, $I_{TM}=I_{T(AV)},t_p>200~\mu s,V_R=100~V,dI/dt=-10~A/\mu s,dV/dt=20~V/\mu s$ linear to 67 % $V_{DRM},$ gate bias 0 V to 100 W	110	F-G

Note

• $t_q = 10 \mu s$ up to 600 V, $t_q = 30 \mu s$ up to 1600 V available on special request

BLOCKING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum critical rate of rise	dV/dt	$T_J = T_J$ maximum linear to 100 % rated V_{DRM}	100	V/µs	
of off-state voltage	uv/ut	$T_J = T_J$ maximum linear to 67 % rated V_{DRM}	300 (1)	ν/μδ	

Note

(1) Available with: $dV/dt = 1000 V/\mu s$, to complete code add S90 i.e. 22RIA120S90



TRIGGERING					
PARAMETER	SYMBOL	TES	T CONDITIONS	VALUES	UNITS
Maximum peak gate power	P_{GM}	$T_{.1} = T_{.1}$ maximum	T. T		W
Maximum average gate power	P _{G(AV)}	I J = I J Maximum		2.0	۷V
Maximum peak positive gate current	I _{GM}	T _J = T _J maximum		1.5	Α
Maximum peak negative gate voltage	-V _{GM}	$T_J = T_J$ maximum		10	V
		T _J = - 65 °C	Maximum required gate trigger current/voltage are the lowest value which will trigger all units	90	
DC gate current required to trigger	I _{GT}	T _J = 25 °C		60	mA
		T _J = 125 °C		35	
	V _{GT}	T _J = - 65 °C		3.0	
DC gate voltage required to trigger		T _J = 25 °C	6 V anode to cathode applied	2.0	V
		T _J = 125 °C		1.0	
DC gate current not to trigger	I_{GD}	$T_J = T_J$ maximum, $V_{DRM} = Rated$ value		2.0	mA
DC gate voltage not to trigger	V _{GD}	$T_J = T_J$ maximum, $V_{DRM} = Rated value$	Maximum gate current/voltage not to trigger is the maximum value which will not trigger any unit with rated V _{DRM} anode to cathode applied	0.2	٧

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VAL	VALUES		
Maximum operating junction and storage temperature range	T _J , T _{Stg}		-65 t	o 125	°C	
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	0.	0.86		
Maximum thermal resistance, case to heatsink	R _{thCS}	Mounting surface, smooth, flat and greased 0.35		.35	K/W	
			TO NUT	TO DEVICE		
			20 (27.5)	25	lbf ⋅ in	
Mounting torque		Lubricated threads (Non-lubricated threads)	0.23 (0.32)	0.29	kgf · m	
		(10) 102/102/103	2.3 (3.1)	2.8	N·m	
Approximate weight			1	14	g	
Approximate weight			0.	.49	OZ.	
Case style		See dimensions - link at the end of datasheet	TC	D-208AA (TO-	48)	

△R _{thJC} CONDUCTION						
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS		
180°	0.21	0.15				
120°	0.25	0.25				
90°	0.31	0.34	$T_J = T_J$ maximum	K/W		
60°	0.45	0.47				
30°	0.76	0.76				

Note

• The table above shows the increment of thermal resistance RthJC when devices operate at different conduction angles than DC

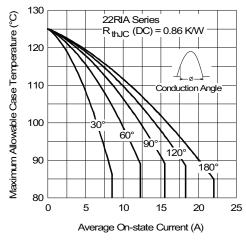


Fig. 1 - Current Ratings Characteristics

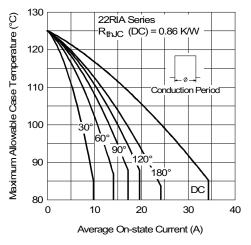


Fig. 1 - Current Ratings Characteristics

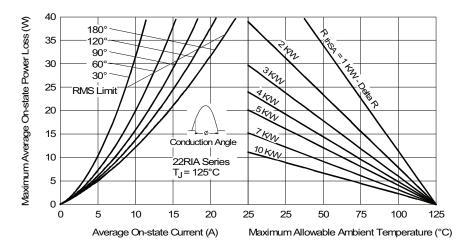


Fig. 2 - On-State Power Loss Characteristics

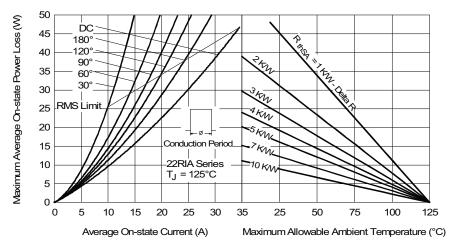


Fig. 3 - On-State Power Loss Characteristics

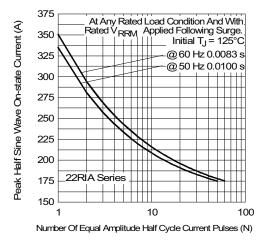


Fig. 4 - Maximum Non-Repetitive Surge Current

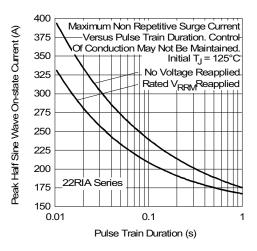


Fig. 5 - Maximum Non-Repetitive Surge Current

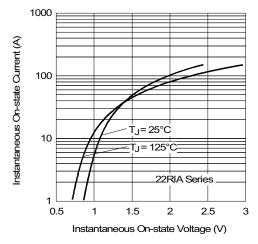


Fig. 6 - Forward Voltage Drop Characteristics

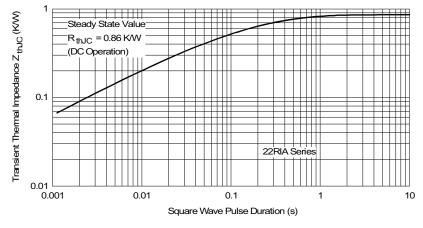


Fig. 7 - Thermal Impedance Z_{thJC} Characteristics

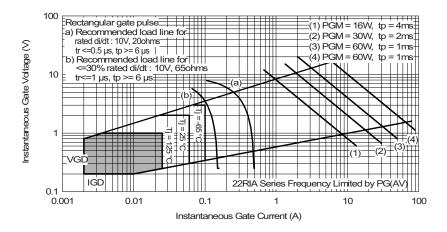
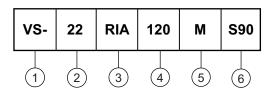


Fig. 8 - Gate Characteristics

ORDERING INFORMATION TABLE

Device code



Vishay Semiconductors product

2 - Current code

3 - Essential part number

Voltage code x 10 = V_{RRM} (see Voltage Ratings table)

5 - None = Stud base TO-208AA (TO-48) 1/4" 28UNF-2A

M = Stud base TO-208AA (TO-48) M6 x 1

6 - Critical dV/dt:

None = 300 V/µs (standard value)

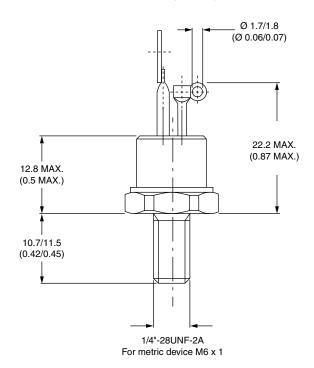
S90 = 1000 V/µs (special selection)

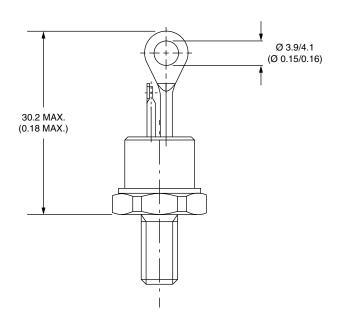
LINKS TO RELAT	ED DOCUMENTS
Dimensions	www.vishay.com/doc?95333

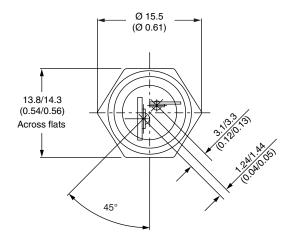


TO-208AA (TO-48)

DIMENSIONS in millimeters (inches)









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